



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicant: Dongming Zhu et al.
Title: LOW CONDUCTIVITY AND SINTERING-RESISTANT THERMAL
BARRIER COATINGS
Serial No.: 09/904,084 Art Unit: 1755
Filed: July 12, 2001
Examiner: Paul Marcantoni
Docket: 33253US1

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. § 1.98, applicant is submitting herewith Form PTO-1449 listing references for consideration by the Examiner. Also submitted herewith is a legible copy of each reference listed.

If any further fees are required by this communication, please charge such fees to our Deposit Account No. 16-0820, Order No. 33253US1.

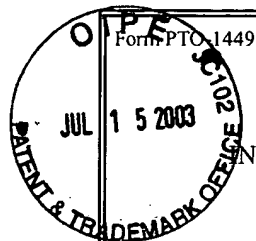
Respectfully submitted,

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Date: 7-16-03



Form PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICEATTY. DOCKET NO.
33253US1SERIAL NO.
09/904,084INFORMATION DISCLOSURE CITATION
BY APPLICANT
(USE SEVERAL SHEETS IF NECESSARY)

APPLICANT:

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U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Date	Name	Class	Subclass	Filing Date If Appropriate
	A	4,055,705	10/1977	Stecura et al.			
	B	5,652,044	7/1997	Rickerby			
	C	6,025,078	2/2000	Rickerby et al.			
	D	6,440,575	8/2002	Heimberg et al.			
	E						
	F						
	G						
	H						
	I						
	J						
	K						
	L						
	M						

FOREIGN PATENT DOCUMENTS

		Document No.	Date	Country	Class	Subclass	Translation
	N	94/08069	4/1994	WO			
	P						

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

	Q	
	R	

Examiner:

Date Considered

*Examiner: Initial if reference considered, regardless of whether citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.